

DATA SHEET

THIN FILM CHIP RESISTORS
AUTOMOTIVE GRADE

AT series
0.01% to 1%, TC5 to TC50
sizes 0402/0603/0805/1206
RoHS compliant



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SCOPE

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This specification describes AT0402 to AT1206 high precision-high stability chip resistors made by thin film process.

<u>APPLICATIONS</u>

- Automotive electronics
- Industrial and medical equipment
- Test and measuring equipment
- Telecommunications

FEATURES

- · AEC-Q200 qualified
- Total lead free without RoHS exemption
- Halogen free epoxy
- Superior resistance against sulfur containing atmosphere
- Moisture sensitivity level: MSL I
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Non-forbidden materials used in products/production

ORDERING INFORMATION - GLOBAL PART NUMBER

Part number is identified by the series name, size, tolerance, packaging type, temperature coefficient, taping reel and resistance value.

GLOBAL PART NUMBER

AT XXXX X X X XX XXXXX L

(1) (2) (3) (4) (5) (6) (7)

(I) SIZE

0402 / 0603 / 0805 / 1206

(2) TOLERANCE

 $B = \pm 0.1\%$

 $C = \pm 0.25\%$

 $D = \pm 0.5\%$

 $F = \pm 1\%$

 $L = \pm 0.01\%$

 $P = \pm 0.02\%$

 $W = \pm 0.05\%$

(3) PACKAGING TYPE

R = Paper taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

 $A = \pm 5 \text{ ppm/}^{\circ}\text{C}$

 $B = \pm 10 \text{ ppm/}^{\circ}\text{C}$

 $C = \pm 15 \text{ ppm/}^{\circ}C$

 $D = \pm 25 \text{ ppm/°C}$

 $E = \pm 50 \text{ ppm/°C}$

(5) TAPING REEL

07 = 7 inch dia. Reel

(6) RESISTANCE VALUE

There are 2~4 digits indicated the resistor value.

Letter R/K/M is decimal point

Example: $100R = 100\Omega$

 $IK = I,000\Omega$

(7) DEFAULT CODE

Letter L is the system default code for ordering only. (NOTE)

ORDERING EXAMPLE

The ordering code of a AT0402 chip resistor, TC 25 value 56 Ω with \pm 0.5% tolerance, supplied in 7-inch tape reel is: AT0402DRD0756RL.

NOTE

- I. All our Rchip products meet RoHS compliant and Halogen Free. "LFP" of the internal 2D reel label mentions "Lead Free Process".
- 2. On customized label, "LFP" or specific symbol can be printed.





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AT0402



No marking

AT0603



E-96 series: including values 10/11/13/15/20/75 of E-24 series, 3 digits



E-24 series: exception values 10/11/13/15/20/75 of E-24 series, one short bar under marking letter

AT0805 / AT1206



Both E-24 and E-96 series: 4 digits
First three digits for significant figure and 3rd digit for number of zeros

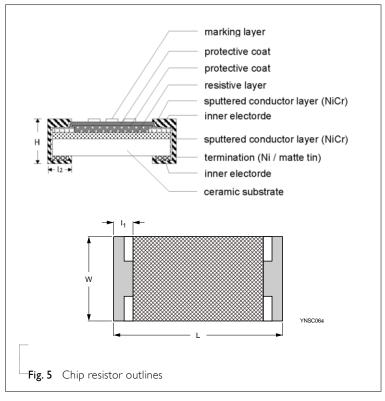
NOTE

For further marking information, please see special data sheet "Chip resistors marking".

CONSTRUCTION

A metal film layer is deposited on a high grade ceramic body (aluminium oxide). This resistive layer is trimmed to its nominal value and on both ends a contact is made which will guarantee optimum solderability. This is achieved by applying several layers and for ease of soldering the outer layer consists of Ni/matte tin. The resistive layer is covered with a protective coating.

OUTLINES







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DIMENSIONS

Table I

TYPE	L (mm)	W (mm)	H (mm)	I _I (mm)	I ₂ (mm)
AT0402	1.00 ±0.10	0.50 ±0.05	0.30 ±0.05	0.20 ±0.10	0.25 ±0.10
AT0603	1.60 ±0.10	0.80 ±0.10	0.45 ±0.10	0.25 ±0.15	0.25 ±0.15
AT0805	2.00 ±0.10	1.25 ±0.10	0.50 ±0.10	0.35 ±0.20	0.35 ±0.20
AT1206	3.10 ±0.10	1.60 ±0.10	0.55 ±0.10	0.45 ±0.20	0.40 ±0.20

ELECTRICAL CHARACTERISTICS

Table 2

	Operating		Max.	Max.	Dielectric	Resis	stance Ra	nge (E-24	/E-96 ser	ies)(Ω)	& Tolera	ance ^(I)	
	Temperature	Power	Working		Withstanding	T.C.R.	±0.01%	±0.02%	±0.05%	±0.1%	±0.25%	±0.5%	±1%
TYPE	Range	Rating	Voltage	Voltage	Voltage	(ppm/°C) ⁽²⁾	(L)	(P)	(W)	(B)	(C)	(D)	(F)
				100 V	- 100 V _	±50 (E)	_	50 ≤ R < IIK		10 ≤ R ≤	≤ 100K		
						±25 (D)	_			10 ≤ R ≤	≤ 100K		
AT0402		1/16W	50 V			±15 (C)	_ 5			10 ≤ R	< K		
						±10 (B)	_			50 ≤ R < I I K			
						±5 (A)				50 ≤ F	R < 11K		-
				150 V		±50 (E)	_			10 ≤ R ≤	≤ 330K		
AT0603		1/10W 75V			_	±25 (D)	_	10 ≤ R ≤ 330K					
			75V		100 V	±15 (C)	_ 5	50 ≤ R < 14K		10 ≤ R < 14K			
				±10 (B)	_		50 ≤ R < 14K						
	_55 °C to					±5 (A)				50 ≤ F	R < 14K		_
	+155 °C				_	±50 (E)	_				10 ≤ R	≤ IM	
		1/8W 150			300 V	±25 (D)	_				10 ≤ R	≤ IM	
AT0805			150 V	300 V		±15 (C)	_ 5	50 ≤ R < I	7K		10 ≤ R	< 17K	
AT1206					_	±10 (B)	_				50 ≤ R	< 17K	
					·	±5 (A)				50 ≤ F	R < 17K		-
					±50 (E)			10 ≤ R	≤ IM				
					±25 (D)					$10 \le R$	≤ IM		
		1/4W	1/4W 200 V	400 V	500 V	±15 (C)	50 ≤ R < 20K	10 ≤ R < 20K					
					-	±10 (B)	_				50 ≤ R	< 20K	
						±5 (A)				50 ≤ F	R < 20K		-

NOTE: I. Global part number (code 7) 2. Global part number (code 9)



FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PRODUCT TYPE	PATKING STYLE	REEL DIMENSION	QUANTITY PER REEL
AT0402	Paper taping reel	7" (178 mm)	10,000 Units
AT0603	Paper taping reel	7" (178 mm)	5,000 Units
AT0805	Paper taping reel	7" (178 mm)	5,000 Units
AT1206	Paper taping reel	7" (178 mm)	5,000 Units

NOTE: for paper tape and reel specification/dimensions, please see the special data sheet "packing" document.

FUNCTIONAL DESCRIPTION

OPERATING TEMPERATURE RANGE

Range: -55 °C to +155 °C

POWER RATING

Each type rated power at 70 °C: AT0402=1/16 W AT0603=1/10 W AT0805=1/8 W

AT1206=1/4 W

RATED VOLTAGE

The DC or AT (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{(P \times R)}$$

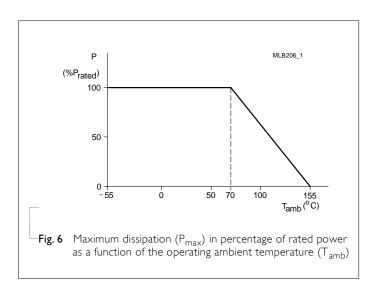
Or max. working voltage whichever is less

Where

V=Continuous rated DC or AC (rms) working voltage (v)

P=Rated power

R=Resistance value (Ω)





TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

ΓEST	TEST METHOD	PROCEDURE	REQUIREMENTS		
Short Time Overload	IEC60115-1 4.13	2.5 times of rated voltage or maximum overload voltage, the less of the above, for 5 sec at room temperature	±(0.05%+0.05Ω)		
High	AEC-Q200 Test 3	1,000 hours at Tamb = 125 °C, unpowered	±(0.1%+0.05Ω)		
Temperature Exposure	MIL-STD-202 Method 108	1,000 hours at Tamb = 155 °C, unpowered	±(0.3%+0.05Ω)		
Moisture	AEC-Q200 Test 6	Each temperature / humidity cycle is defined at	±(0.1%+0.05Ω)		
Resistance	MIL-STD-202 Method 106	8 hours (method 106F), 3 cycles / 24 hours for			
		10d. with 25 °C / 65 °C 95% R.H, without steps			
		7a & 7b, unpowered			
		Parts mounted on test-boards, without condensation on parts			
Biased	AEC-Q200 Test 7	1,000 hours; 85 °C / 85% RH	±(0.1%+0.05Ω)		
Humidity	MIL-STD-202 Method 103	10% of operating power			
		Measurement at 24±4 hours after test conclusion			
Operational Life	AEC-Q200 Test 8 MIL-STD-202 Method 108	I,000 hours at 70±5 °C, RCWV applied for I.5 hours on, 0.5 hour off, still air required	±(0.1%+0.05Ω)		
		1,000 hours at 125 °C, derated voltage applied for 1.5 hours on, 0.5 hour off, still air required	±(0.3%+0.05Ω)		
Resistance to Soldering Heat	AEC-Q200 Test 15 MIL-STD-202 Method 210	Condition B, no pre-heat of samples Lead-free solder, 260±5 °C, 10±1 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	±(0.05%+0.05Ω)		
Thermal	AEC-Q200 Test 16	-55/+125 °C	±(0.1%+0.05Ω)		
Shock	MIL-STD-202 Method 107	Number of cycles is 300. Devices mounted Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air — Air	No visible damage		
Solderability	AEC-Q200 Test 18	Electrical Test not required Magnification 50X	Well tinned		
- Wetting	J-STD-002	SMD conditions:	(>95% covered)		
		(a) Method B, aging 4 hours at 155 °C dry heat, dipping at 235±3 °C for 5±0.5 seconds. (b) Method B, steam aging 8 hours, dipping at 215±3 °C for 5±0.5 seconds.	No visible damage		
		(c) Method D, steam aging 8 hours, dipping at 260 ± 3 °C for 7 ± 0.5 seconds			





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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Board Flex / Bending	AEC-Q200 Test 21 AEC-Q200-005	Chips mounted on a 90mm glass epoxy resin PCB (FR4) Bending for 0402: 5 mm 0603/0805: 3 mm I 206: 2mm Holding time: minimum 60 second	±(0.1%+0.05Ω)
Temperature Coefficient of Resistance (T.C.R.)	IEC 60115-1 4.8	At +25/–55 °C and +25/+125°C Formula: $T.C.R = \frac{R2 - R1}{R1 (t2 - t1)} \times 10^{6} (ppm/°C)$ Where	Refer to table 2
Flower of Sulfur	ASTM-B-809-95*	t1=+25 °C or specified room temperature t2=-55 °C or +125 °C test temperature R1=resistance at reference temperature in ohms R2=resistance at test temperature in ohms Sulfur 750 hours, 105°C, unpowered.	±(4.0%+0.05Ω)
Sullur	* Modified		



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REVISION HISTORY

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REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 6	Apr. 15, 2021	-	- Add tol. ±0.01%, 0.02%, 0.05% ; TCR 5ppm & 10ppm
Version 5	Oct. 24, 2017	-	- Add resistance range for ±15 ppm/°C
Version 4	Mar. 16, 2016	-	- Remove FOS 90°C test
Version 3	Dec. 11, 2015	-	- Modify Outline
Version 2	May 11, 2015	-	- Modify FOS test
Version I	Jun. 18, 2014	-	- Modify FOS test
Version 0	May 07, 2014	-	- First issue of this specification





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